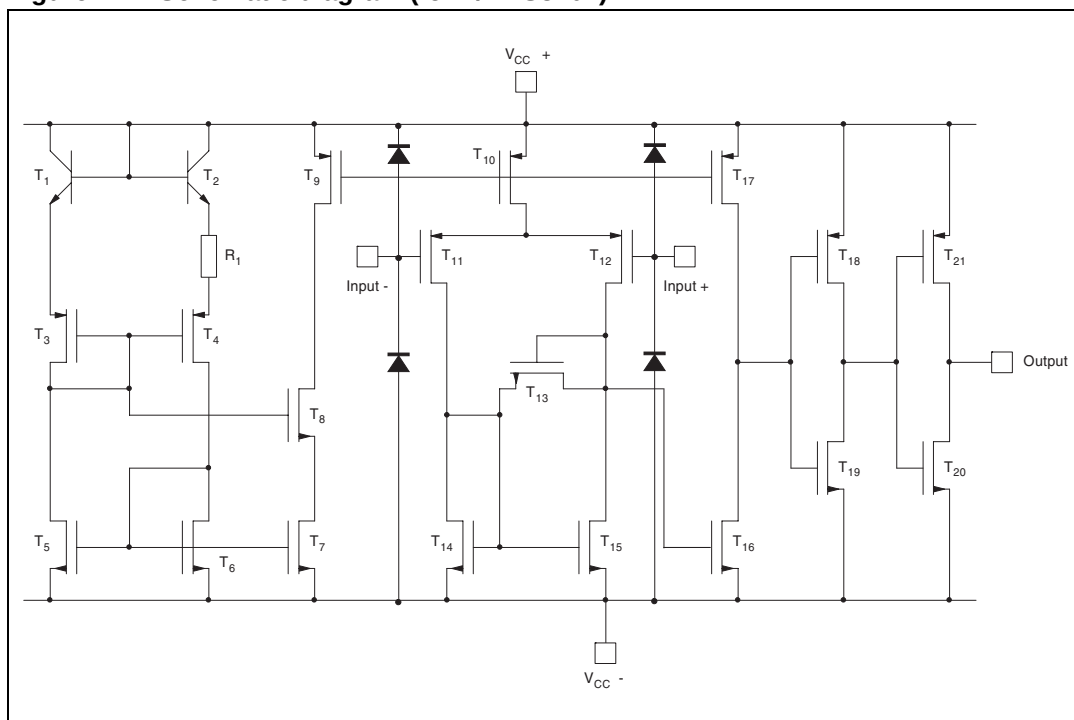


1 Schematic diagram

Figure 1. Schematic diagram (for 1/2 TS3702)



2 Absolute maximum ratings and operating conditions

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{CC}^{+}	Supply voltage ⁽¹⁾	18	V
V_{id}	Differential input voltage ⁽²⁾	± 18	V
V_i	Input voltage ⁽³⁾	18	V
V_o	Output voltage	18	V
I_o	Output current	20	mA
I_F	Forward current in ESD protection diodes on input ⁽⁴⁾	50	mA
P_d	Power dissipation ⁽⁵⁾ DIP8 SO8 TSSOP8	1250 710 625	mW
T_{stg}	Storage temperature range	-65 to +150	°C
ESD	HBM: human body model ⁽⁶⁾	400	V
	MM: machine model ⁽⁷⁾	50	V
	CDM: charged device model ⁽⁸⁾	1.5	kV

1. All voltage values, except differential voltage, are with respect to network ground terminal.
2. Differential voltages are the non-inverting input terminal with respect to the inverting input terminal.
3. The magnitude of the input and the output voltages must never exceed the magnitude of the positive and negative supply voltages.
4. Guaranteed by design.
5. P_d is calculated with $T_{amb} = +25^{\circ}\text{C}$, $T_j = +150^{\circ}\text{C}$ and
 $R_{thja} = 100^{\circ}\text{C/W}$ for DIP8 package
 $R_{thja} = 175^{\circ}\text{C/W}$ for SO8 package
 $R_{thja} = 200^{\circ}\text{C/W}$ for TSSOP8 package
6. Human body model: A 100pF capacitor is charged to the specified voltage, then discharged through a 1.5k Ω resistor between two pins of the device. This is done for all couples of connected pin combinations while the other pins are floating.
7. Machine model: A 200pF capacitor is charged to the specified voltage, then discharged directly between two pins of the device with no external series resistor (internal resistor < 5 Ω). This is done for all couples of connected pin combinations while the other pins are floating.
8. Charged device model: all pins and the package are charged together to the specified voltage and then discharged directly to the ground through only one pin. This is done for all pins.

Table 2. Operating conditions

Symbol	Parameter	Value	Unit
V_{CC}^{+}	Supply voltage TS3702C, TS3702I TS3702M	2.7 to 16 4 to 16	V
V_{icm}	Common mode input voltage range	0 to $V_{CC}^{+} - 1.5$	V
T_{oper}	Operating free-air temperature range TS3702C TS3702I TS3702M	0 to +70 -40 to +125 -55 to +125	°C

3 Electrical characteristics

Table 3. $V_{CC}^+ = 3V$, $V_{CC}^- = 0V$, $T_{amb} = 25^\circ C$ (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit
V_{io}	Input offset voltage ⁽¹⁾ $V_{ic} = 1.5V$ $T_{min} \leq T_{amb} \leq T_{max}$			5 6.5	mV
I_{io}	Input offset current ⁽²⁾ $V_{ic} = 1.5V$ $T_{min} \leq T_{amb} \leq T_{max}$		1	300	pA
I_{ib}	Input bias current ⁽²⁾ $V_{ic} = 1.5V$ $T_{min} \leq T_{amb} \leq T_{max}$		1	600	pA
V_{icm}	Input common mode voltage range $T_{min} \leq T_{amb} \leq T_{max}$	0 0		$V_{CC}^+ - 1.2$ $V_{CC}^+ - 1.5$	V
CMR	Common-mode rejection ratio $V_{ic} = V_{icm\ min}$		80		dB
SVR	Supply voltage rejection ratio $V_{CC}^+ = 3V$ to $5V$		75		dB
V_{OH}	High level output voltage $V_{id} = 1V$, $I_{OH} = -4mA$ $T_{min} \leq T_{amb} \leq T_{max}$	2 1.8	2.4		V
V_{OL}	Low level output voltage $V_{id} = -1V$, $I_{OL} = 4mA$ $T_{min} \leq T_{amb} \leq T_{max}$		300	400 575	mV
I_{CC}	Supply current (each comparator) No load - Outputs low $T_{min} \leq T_{amb} \leq T_{max}$		7	20 25	μA
t_{PLH}	Response time low to high $V_{ic} = 0V$, $f = 10kHz$, $C_L = 50pF$, overdrive = $5mV$ TTL input		1.5 0.7		μs
t_{PHL}	Response time high to low $V_{ic} = 0V$, $f = 10kHz$, $C_L = 50pF$, overdrive = $5mV$ TTL input		2.2 0.15		μs

1. The specified offset voltage is the maximum value required to drive the output up to 2.5V or down to 0.3V.
2. Maximum values include unavoidable inaccuracies of the industrial tests.

Table 4. $V_{CC}^+ = 5V$, $V_{CC}^- = 0V$, $T_{amb} = 25^\circ C$ (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit
V_{io}	Input offset voltage $V_{ic} = V_{icm\ min}$, $V_{CC}^+ = 5V$ to $10V$ ⁽¹⁾ $T_{min} \leq T_{amb} \leq T_{max}$		1.2	5 6.5	mV
I_{io}	Input offset current ⁽²⁾ $V_{ic} = 2.5V$ $T_{min} \leq T_{amb} \leq T_{max}$		1	300	pA
I_{ib}	Input bias current ⁽²⁾ $V_{ic} = 2.5V$ $T_{min} \leq T_{amb} \leq T_{max}$		1	600	pA
V_{icm}	Input common mode voltage range $T_{min} \leq T_{amb} \leq T_{max}$	0 0		$V_{CC}^+ - 1.2$ $V_{CC}^+ - 1.5$	V
CMR	Common-mode rejection ratio $V_{ic} = V_{icm\ min}$		82		dB
SVR	Supply voltage rejection ratio $V_{CC}^+ = +5V$ to $+10V$		90		dB
V_{OH}	High level output voltage $V_{id} = 1V$, $I_{OH} = -4mA$ $T_{min} \leq T_{amb} \leq T_{max}$	4.5 4.3	4.7		V
V_{OL}	Low level output voltage $V_{id} = -1V$, $I_{OL} = 4mA$ $T_{min} \leq T_{amb} \leq T_{max}$		200	300 375	mV
I_{CC}	Supply current (each comparator) No load - Outputs low $T_{min} \leq T_{amb} \leq T_{max}$		9	20 25	μA
t_{PLH}	Response time low to high $V_{ic} = 0V$, $f = 10kHz$, $C_L = 50pF$, overdrive = 5mV Overdrive = 10mV Overdrive = 20mV Overdrive = 40mV TTL input		1.5 1.1 0.9 0.7 0.6		μs
t_{PHL}	Response time high to low $V_{ic} = 0V$, $f = 10kHz$, $C_L = 50pF$, overdrive = 5mV Overdrive = 10mV Overdrive = 20mV Overdrive = 40mV TTL input		2.2 1.6 1.1 0.75 0.17		μs
t_f	Fall time $f = 10kHz$, $C_L = 50pF$, overdrive 50mV		30		ns

1. The specified offset voltage is the maximum value required to drive the output up to 4.5V or down to 0.3V.
2. Maximum values include unavoidable inaccuracies of the industrial tests.

4 Package information

In order to meet environmental requirements, STMicroelectronics offers these devices in ECOPACK[®] packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an STMicroelectronics trademark. ECOPACK specifications are available at: www.st.com.

4.1 DIP8 package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A		3.3			0.130	
a1	0.7			0.028		
B	1.39		1.65	0.055		0.065
B1	0.91		1.04	0.036		0.041
b		0.5			0.020	
b1	0.38		0.5	0.015		0.020
D			9.8			0.386
E		8.8			0.346	
e		2.54			0.100	
e3		7.62			0.300	
e4		7.62			0.300	
F			7.1			0.280
I			4.8			0.189
L		3.3			0.130	
Z	0.44		1.6	0.017		0.063

The image contains three mechanical drawings of the DIP8 package. The top-left drawing is a side view showing dimensions A, a1, B, B1, b, b1, e, e3, e4, F, I, L, and Z. The top-right drawing is an end view showing dimensions e4 and b1. The bottom drawing is a top view showing dimensions D, L, and pin numbers 1, 4, 5, and 8.

4.2 SO8 package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	1.35		1.75	0.053		0.069
A1	0.10		0.25	0.04		0.010
A2	1.10		1.65	0.043		0.065
B	0.33		0.51	0.013		0.020
C	0.19		0.25	0.007		0.010
D	4.80		5.00	0.189		0.197
E	3.80		4.00	0.150		0.157
e		1.27			0.050	
H	5.80		6.20	0.228		0.244
h	0.25		0.50	0.010		0.020
L	0.40		1.27	0.016		0.050
k	8° (max.)					
ddd			0.1			0.04

The mechanical drawings illustrate the SO8 package geometry. The side view (top left) defines dimensions D (body width), A (total height), A1 (lead height), A2 (body height), and B (lead thickness). The lead detail (top right) shows a 45-degree bend and dimension C (lead thickness). The top view (bottom left) shows dimensions E (body length), H (total length), e (pitch), and pin numbering 1, 4, 5, 8. The side view with lead (bottom right) shows dimension L (lead length), k (lead angle), and a 0.25 mm gage plane for measurement.

4.3 TSSOP8 package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.2			0.047
A1	0.05		0.15	0.002		0.006
A2	0.80	1.00	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
c	0.09		0.20	0.004		0.008
D	2.90	3.00	3.10	0.114	0.118	0.122
E	6.20	6.40	6.60	0.244	0.252	0.260
E1	4.30	4.40	4.50	0.169	0.173	0.177
e		0.65			0.0256	
K	0°		8°	0°		8°
L	0.45	0.60	0.75	0.018	0.024	0.030
L1		1			0.039	

The mechanical drawing illustrates the TSSOP8 package geometry. It includes a side view showing the package height (D) and lead length (L). A top view shows the package width (E) and pin pitch (e). A detail view shows the lead profile with dimensions A, A1, A2, b, and c. A gage plane is indicated at 0.25 mm (.010 inch) from the lead tip. The package is shown with a seating plane and a pin 1 identification mark.

5 Ordering information

Table 5. Order codes

Part number	Temperature range	Package	Packaging	Marking
TS3702CN	0°C, +70°C	DIP8	Tube	TS3702CN
TS3702CD/CDT		SO8	Tube or tape & reel	3702C
TS3702IN	-40°C, +125°C	DIP8	Tube	TS3702IN
TS3702ID/IDT		SO8	Tube or tape & reel	3702I
TS3702IPT		TSSOP8	Tape & reel	3702I
TS3702MN	-55°C, +125°C	DIP8	Tube	TS3702MN
TS3702MD/MDT		SO8	Tube or tape & reel	3702M
TS3702MPT		TSSOP8	Tape & reel	3702M

6 Revision history

Date	Revision	Changes
2-Jan-2003	1	First release.
2-May-2005	2	PPAP references inserted in the datasheet, see Section 5: Ordering information on page 10 .
26-Feb-2007	3	PPAP references removed. ESD data added to Table 1 on page 3 . Order codes added to Table 5 on page 10 .

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